

 Material Composition Declaration Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.		This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
1752-2 1.1		IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x			Form Type * Distribute		Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information			
Supplier Information										
Company Name * National Semiconductor		Company Unique ID NATSEMI		Unique ID Authority 04-147-2986		Response Date * 06-02-2009		Response Document ID		
Contact Name * Elizabeth Cathers		Title - Contact Product Ecology Eng. Mgr		Phone - Contact * 1-408-721-5248		Email - Contact * Green.Project@nsc.com				
Authorized Representative * Elizabeth Cathers		Title - Representative Product Ecology Eng. Mgr		Phone - Representative * 1-408-721-5248		Email - Representative * Green.Project@nsc.com		Supplier Comments or URL for Additional Information http://www.national.com/analog/quality/green		
	Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight *	UOM	Unit Type	
		SCANSTA112SM NOPB	SCANSTA112SM NOPB	06-02-2009			266.64	mg	Each	
	Alternate Recommendation				Alternate Item Comments					
Manufacturing Process Information										
Terminal Plating / Grid Array Material SnAgCu		Terminal Base Alloy Not Applicable		J-STD-020 MSL Rating 4		Peak Process Body Temperature 260 C		Max Time at Peak Temperature 40 seconds		Number of Reflow Cycles 4
Comments "Does not contain PFOS."										

RoHS Material Type Declaration	Declaration Type * Custom
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RoHS Directive 2002/95/EC	RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium
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Subject to the limitations below, National Semiconductor Corporation ("National") certifies the following information as of the document date.

1. National products designated "ROHS Compliant" comply with the European Unions Directive on the Restriction of the Use of Hazardous Substances 2002/95/EC ("RoHS"). Certain National products contain lead in RoHS exempt applications 5, 7a or 7c.
2. National products do not contain and are not manufactured with ozone depleting compounds.
3. National products do not contain substances identified by the European Chemical Agency ("ECHA") as substances of very high concern ("SVHC").
4. National products are manufactured in conformance with National specifications (SC)CSP-9-111C1 Supplier Environmental Requirements for Materials and Products and (SC)CSP-9-111S2 Banned and Reportable Substances.
5. National's list of banned and reportable substances and management system is based on the current version of the Joint Industrial Guide, JIG-101.

National has taken commercially reasonable steps to provide representative and accurate information but may not have independently verified information provided or conducted chemical analysis of incoming materials. Equivalent compliant materials may have been substituted for those stated herein. Material concentrations are the maximum expected concentration of the substance in the device and may not represent the actual concentration. National and its suppliers consider certain limited information to be confidential and thus CAS numbers and other limited information may not be available for release. National's Standard Terms and Conditions of Sale apply to any issue arising out of or in connection with the information provided herein unless otherwise provided by a written contract signed by both parties.

NATIONAL ACCEPTS NO DUTY TO NOTIFY USERS OF THIS DECLARATION OF UPDATES OR CHANGES TO THIS DECLARATION

RoHS Declaration * 1 - Item(s) does not contain RoHS restricted substances per the definition above	Supplier Acceptance *	Accepted
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Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration and above and choose all applicable exemptions.

Declaration Signature	
Supplier Signature	 Gerry Edwards Vice President Quality

Homogeneous Material Composition Declaration for Electronic Products

Item/SubItem Name	Homogeneous Material	Weight	Unit of Measure	Level	Substance Category	Substance	CAS	Exempt	Weight	Unit of Measure	Tolerance	PPM
	Chip	25.470	mg	Requester		Si	7440-21-3		25.317	mg		994,000
				Requester		Al	7429-90-5		0.153	mg		6,000
	Die Attach	3.100	mg	Requester		Ag	7440-22-4		2.325	mg		750,000
				Requester		Bismaleimide (resin)	13676-54-5		0.775	mg		250,000
	Plastic	113.490	mg	Requester		SiO2	60676-86-0		98.396	mg		867,000
				Requester		Epoxy Resin	25928-94-3		13.619	mg		120,000
				Requester		Sb2O3	1309-64-4		1.021	mg		9,000
				Requester		Brominated Epoxy	40039-93-8		0.454	mg		4,000
	Solder Balls	36.930	mg	Requester		Sn	7440-31-5		35.453	mg		960,000
				Requester		Ag	7440-22-4		1.293	mg		35,000
				Requester		Cu	7440-50-8		0.185	mg		5,000
	Substrate	84.790	mg	Requester		BT	N/A		34.764	mg		410,000
				Requester		Cu	7440-50-8		28.150	mg		332,000
				Requester		Solder Mask	N/A		11.023	mg		130,000
				Requester		Ni	7440-02-0		9.327	mg		110,000
				Requester		Au	7440-57-5		1.526	mg		18,000
	Wires	2.860	mg	Requester		Au	7440-57-5		2.860	mg		1,000,000